Thematic Symposium - Integrity of Mechanical Structures and Material Special Issue of the Selected Papers in TS-IMSM 2024

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DESCRIPTION

Curved and Layered Structures invites manuscripts for the Special Issue published in cooperation with **The 3rd Thematic Symposium Integrity of Mechanical Structure** and Material.

Thematic Symposium - Integrity of Mechanical Structures and Material (TS-IMSM 2024) will be held on September 19-20, 2024 in Surakarta, Indonesia, for the third time since it was firstly introduced in 2020 by cooperation with DIMONITOR[©] as the Host. The aim of the **Thematic Symposium** is structure-energy collaboration towards sustainable societies.

Scopes of Special Issue are selected to be recent developments of the thin-walled based designs and structures. Topics of interests include (but are not limited) to the following aspects:

- Mechanics of Fluid, Solid, Material and Thermal
- Engineering Structure and Construction
- Experimental Modeling and Applied Engineering
- Manufacture and Production
- Mechanical and Automotive Design
- Wind Engineering
- Aerospace Engineering
- Mechanical Engineering

More information about the Conference, such as deadlines and preliminary schedule, can be accessed at https://tsimsm.org/.

Authors are requested to submit their papers complying the general scope of the journal. The submitted papers will undergo the standard peer-review process before they can be accepted. Notification of acceptance will be communicated as we progress with the review process.

HOW TO SUBMIT

Before submission authors should carefully read the Instruction for Authors.

Manuscripts can be written in TeX, LaTeX, or in standard DOCUMENT (.DOC). For an initial submission, the authors are strongly advised to upload their entire manuscript, including tables and figures, as a single PDF file.

All submissions to the Special Issue must be made electronically via online submission system Editorial Manager: https://www.editorialmanager.com/clstructures.

All manuscripts will undergo the standard peer-review process (single blind, at least two independent reviewers). When entering your submission via online submission system please choose the option "Special Issue: TS-IMSM 2024".

Submission of a manuscript implies that the work described has not been published before as a whole or as a part in any medium by the authors or anyone else and it is not under consideration for publication elsewhere. For more details please see Publishing Ethics and documents available in the Supplementary Materials section at the Curved and Layered Structures website.

The deadline for submissions is December 31, 2024, but individual papers will be reviewed and published online on an ongoing basis.

Contributors to the Special Issue will benefit from:

- indexation in SCOPUS and Web of Science
- APC that amounts to 500 EUR
- fair and constructive peer review provided by experts in the field no space constraints
- convenient, web-based paper submission and tracking system Editorial Manager
- quick online publication upon completing the publishing process (continuous publication model)
- liberal policies on copyrights (authors retain copyrights) and on self-archiving (no embargo periods) **
- better visibility due to Open Access
- long-term preservation of the content
- promotion of published papers to readers and citers

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Curved and Layered Structures applies Article Processing Charges (APC), to cover costs of publication in open access. There is no submission fee.

We are looking forward to your submission!

In case of problems, please contact the Managing Editor (natalia.mikolajczak@degruyter.com) or Assistant Managing Editor (AssistantManagingEditor@degruyter.com) of Curved and Layered Structures.